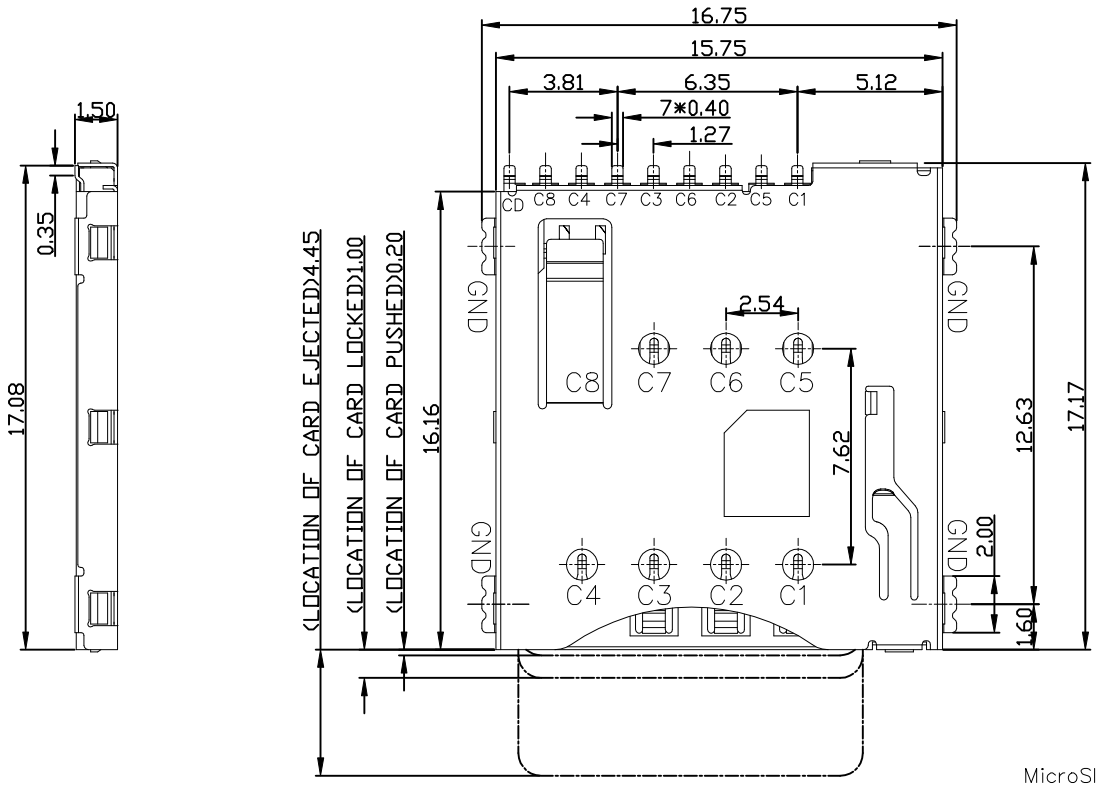
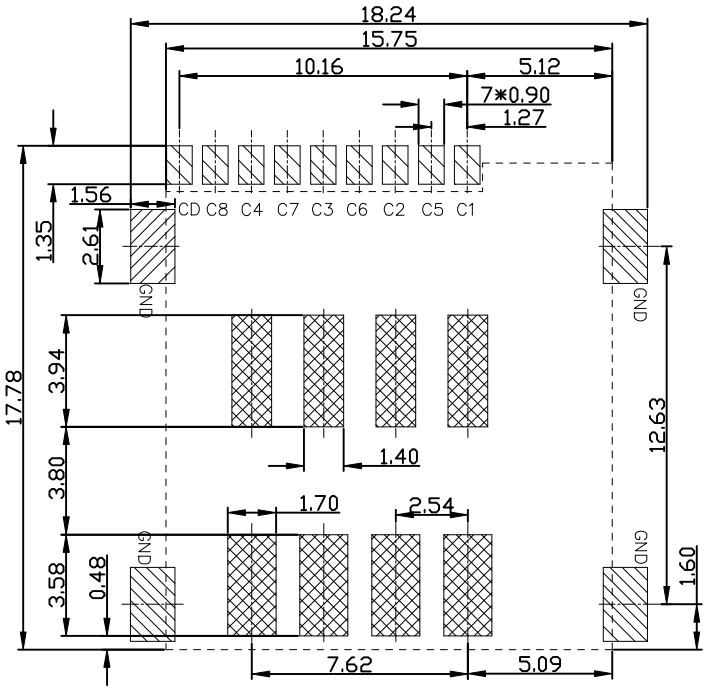
REV.	ECN	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A		NEW RELEASE	2016.03.09			



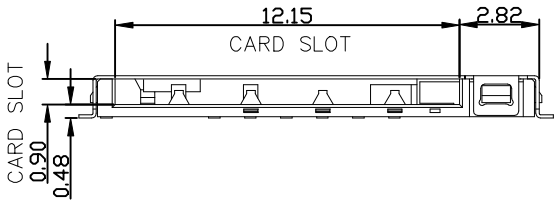


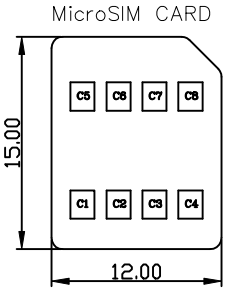
PAD AREA

KEEP OUT AREA

RECOMMENDED P.C.B LAYOUT

COMPONENT SIDE(TOLERANCE ±0.05)





SCALE 1:2

TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 15.75LX17.17WX1.50H mm

Weight: Approx 0.4±0.1g

Durability: 1500 cycles min.

2.Electrical Characteristics

Contact resistance;

Date Contact: 150mΩ max

CD Switch: 500mΩ max

Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vapor phase: 215°C,30sec.Max

IR reflow: 250°C,5sec.Max

Manual soldering: 370°C,3sec.Max

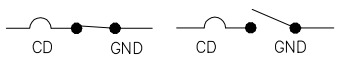
4.Environmental Characteristics

Operating temperature: −40°C~+85°C

Operating humidity: 10%~+95%RH

MicroSIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



SWITCH OPERATION DIAGRAM

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	8	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

MILLIMETERS	INCH
X.° ± 2'	X.° ± 2'
.X ±0.30	.XX ±0.012
.XX ±0.25	.XXX ±0.008
.XXX±0.15	.XXXX±0.004

UNITS MM

MAT'L SEE NOTES

FINISH SEE NOTES

QTY SEE NOTES

广东国连电子有限公司

GUANGDONG GUOLIAN ELECTRONICS CO.,LTD

PART NUMBER:

TITLE: Micro SIM 8+1 PUSH H1.5

APPD: Sean

DWG NO.: MIB5FW1092C8

CHKD:

DR: Yang

SCALE	SHEET	REV.
1:1	1	A